



Industry 5.0.: Current Status, Challenges, and New Strategies

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Message from the Guest Editors

Dear Colleagues,

Industry 4.0 introduced automation technologies, smart manufacturing and IoT; Industry 5.0, however, offers the possibility of collaboration between machines and humans.

Although Industry 4.0 aimed to give priority to automation processes, we now see the opposite trend. Industry 5.0 aims to show us how humans and machines could collaborate. Machine–human interactions offer benefits from a range of different aspects.

However, the impact of each industrial revolution was to generate more effective processes, and Industry 5.0 will offer even better business models.

This Special Issue aims to explore part of the human–computer interaction, digital manufacturing, machine–human interaction and the latest automation technologies.

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Message from the Editor-in-Chief

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